

www.SunLEDusa.com

Part Number: XDMYK100A

101.2mm (4.0") SINGLE DIGIT NUMERIC DIS-PLAY

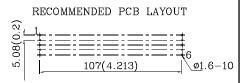


Features

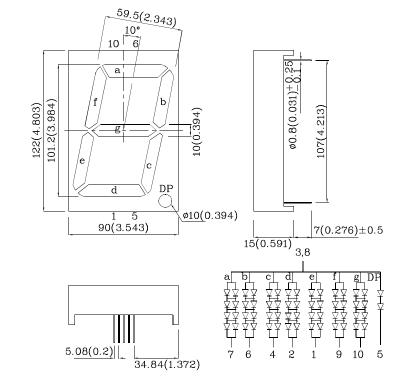
- Low power consumption
- ullet Robust package
- I.C. Compatible
- Standard configuration: Gray face w/ white segments
- Optional black face provides superior color contrast
- RoHS Compliant







Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)	MYK (AlGaInP)	Unit		
Reverse Voltage (Per Chip)	$V_{\rm R}$	5	V	
Forward Current (Dp)	I_{F}	60 (30)	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width (Dp)	i_{FS}	350 (175)	mA	
Power Dissipation (Per Chip)	P_{D}	150	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3-5 Seconds			

Operating Characteristics (T _A =25°C)		MYK (AlGaInP)	Unit
Forward Voltage (Typ.) (Dp) (I _F =10mA)	V_{F}	7.8 (3.9)	V
Forward Voltage (Max.) (Dp) (I _F =10mA)		10 (5.0)	V
Reverse Current (Max.) (Per Chip) (V _R =5V)	I_R	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λΡ	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA)	λD	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	20	pF

 Part Number	Emitting Color	Emitting Material	CIE127-2007* (I _F =10mA) ucd	Wavelength CIE127-2007* nm λP	Description
			min. typ.		
XDMYK100A	Yellow	AlGaInP	150000 449990 52000* 139990*	590*	Common Anode, Rt.Hand Decimal.

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Mar 11,2014

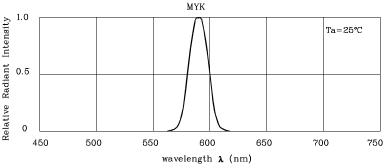
XDSB7724 V1-X Layout: Maggie L.

www.SunLEDusa.com

Part Number: XDMYK100A

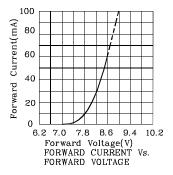
101.2mm (4.0") SINGLE DIGIT NUMERIC DIS-**PLAY**

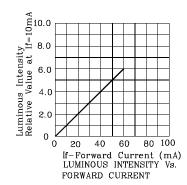


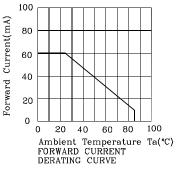


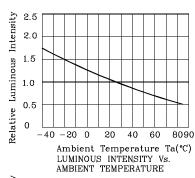
RELATIVE INTENSITY Vs. CIE WAVELENGTH

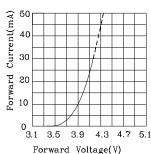
MYK



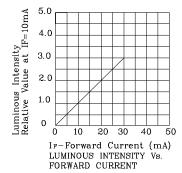


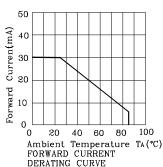


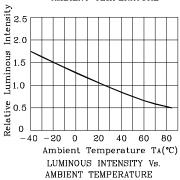




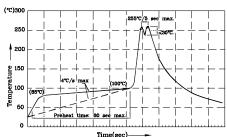
FORWARD CURRENT Vs. FORWARD VOLTAGE







Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- Notes:

 1. Recommend pre-heat temperature of 105°C or less (as measured thermocouple attached to the LED pins) prior to immersion in the wave with a maximum solder bath temperature of 260°C

 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 smax).
- nax₁.

 3. Do not apply stress to the epoxy resin while the
 4.Fixtures should not incur stress on the componen during soldering process.

 5.SAC 305 solder alloy is recommended.

 6. No more than one wave soldering pass.
- No more than one wave soldering pass.

 During wave soldering, the PCB top-surface temperature should be kept below 105°C.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

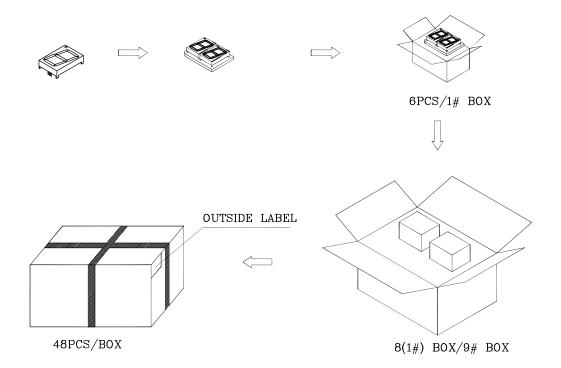
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

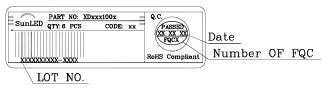
101.2mm (4.0") SINGLE DIGIT NUMERIC DIS-

PLAY

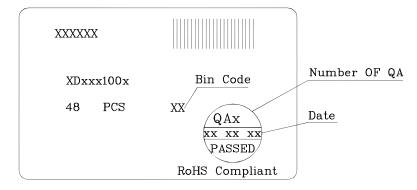
PACKING & LABEL SPECIFICATIONS



Inside Label On 1#BOX



Outside Label On Box



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

Mar 11,2014